## 

(1,00mm) .03937"
FSI SERIES


# LOW PROFILE \& ALEVATED ONE PIECE 

## SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?FSI

Insulator Material:
Liquid Crystal
Polymer
Contact Material:
BeCu
Current Rating:
$1 \mathrm{~A} @ 80^{\circ} \mathrm{C}$ ambient
Operating Temp Range:
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Plating:
Au over $50 \mu^{\prime \prime}(1,27 \mu \mathrm{~m}) \mathrm{Ni}$
RoHS Compliant:
Yes
Processing:
Lead-Free Solderable:
Yes
SMT Lead Coplanarity:
( $0,10 \mathrm{~mm}$ ) .004" max (05-35) ( $0,15 \mathrm{~mm}$ ) . 006 " max ( $40-50$ ) Compression Board: Gold Pads required
Note: Applications requiring
40-50 positions without
threaded inserts, please
contact Samtec Interconnect
Processing Group.
Note: Some lengths,
styles and options are
non-standard, non-returnable.

Also Available



## Due to technical progress, all designs, specifications and components are subject to change without notice.



FSI-120-06-L-S-AD


FSI-130-10-L-D-E

FSI-115-03-G-S-AD

FSI-150-06-L-D-AD


Insert Option (40 \& 50 pins/row)


OTHER OPTION
-SD
= Screw Down
(For mating with FSIF Series Flex Data Link) (10, 20, 30 positions only)
(Threaded insert option not available) (Not available with -S row option or $-06 \&-10$ body height)
-WT
= Weld Tab
(Available with -S row option \& -06 \& -10 body height only)
-K
= Polyimide Film Pick \& Place Pad ( $40 \& 50$ position with threaded insert option only)
$\qquad$
$=$ Plastic Pick \& Place Pad (5,08mm) .200" x (12,45mm).490" ( 40 \& 50 not available with -E) (Not available with -S row option or -03 body height)
-TR

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